

THE CHINESE UNIVERSITY OF HONG KONG
Office of Admissions and Financial Aid

HSBC Overseas Scholarship Programme 2019/20

Information Sheet

HSBC is inviting applications for scholarships which support non-final-year full-time undergraduate students to study in an overseas university for **either one semester or one academic year** in the academic year 2019/20. The maximum amount of each scholarship for the academic year 2019/20 is HK\$300,000.

The Scholarship

The scholarship will enable students who are currently studying under any one of the following disciplines funded by the University Grants Committee to spend a semester or an academic year **AS A VISITING STUDENT** or **AN EXCHANGE STUDENT** at one of the overseas universities listed in Attachment A.

All disciplines under architecture, business and economics, communication, computer science/information systems, construction and land use, dentistry, design, education, engineering, health care, hotel and tourism, law, medicine, science (basic and applied), social sciences, humanities, textiles, arts subjects (linguistics and languages, translation, history, geography, fine arts and applied arts etc), energy and environment, Asian and International Studies, and creative media.

To enable students to have more exposure in their fields of study, students will have the flexibility to major in a different discipline other than the one the student is currently studying while abroad. The discipline, however, will have to be listed in the approved courses listed above.

Students are required to participate in and complete the Hong Kong Young Ambassador Scheme (HKYAS). Please refer to <http://yas.hkfyg.org.hk> for more information about HKYAS. Students may participate in other similar programmes with prior written approval from HSBC.

Students should undertake to abide by the policies and requirements of both The Chinese University of Hong Kong (CUHK) and overseas universities, and to participate actively in campus life and the community while overseas.

Conditional offers will be made in April 2019 to candidates who fulfil all the selection criteria, and are recommended by CUHK and selected by HSBC interview panel. Offers will be confirmed upon receipt of the following documents:

- (1) the official admission letter from the overseas university;
- (2) an application to HKYAS or similar programmes approved by HSBC in writing;
- (3) a letter from the overseas university outlining the duration of the academic year and information on the number of credits/courses that a visiting or full-time overseas student should take; and
- (4) a completed pro-forma summary sheet on the cost breakdown authenticated by the Office of Admissions and Financial Aid of CUHK. Please note that the information on credits to be taken overseas and the costs submitted should be regarded as final. Costs of any additional credits taken during the academic year abroad will not be covered.

HSBC and CUHK do not have any arrangements with the overseas universities designated by HSBC (please refer to Attachment A for the List of Overseas Universities) whereby scholars will be guaranteed admission. Selected candidates are responsible for fulfilling all application procedures and admission requirements at overseas universities of their choice from the List of Overseas Universities (Attachment A) and be offered a place subsequently. **Candidates are, therefore, strongly advised to pay the closest attention to application procedures as soon as possible and selected candidates should secure acceptance independent of HSBC and CUHK.**

Value of the Scholarship

Under the recommendation by CUHK at the time of nomination, a maximum total value of each scholarship is HK\$300,000.

Scholarship amount for each scholar can only go towards (1) tuition fees and mandatory college fees, (2) a minimum economy return airfare, (3) reasonable room and board costs, books, a small portion of living expenses and visa application fees. The scholarship amount does NOT cover insurance, clothing expenses and other incidentals. Please refer to Attachment D for the "Guidelines on How to Calculate an Overseas Scholarship Award Amount" provided by HSBC for details.

Eligibility

The applicants must be :

- registered CUHK students in the tenure year of the scholarship;
- non-final-year full-time undergraduate students;
- currently studying under a discipline funded by the University Grants Committee;
- Hong Kong permanent residents with the right of abode in Hong Kong;
- with a minimum cumulative GPA (i.e. CGPA) score of 3.7 (top 3% of class/department, or equivalent) in the first term of academic year 2018/19;
- well-rounded, participating in extra-curricular and community service activities;
- no extensive experience of living or studying overseas;
- preference will be given to eligible students from disadvantaged backgrounds;
- committed to Hong Kong; and
- with a minimum total TOEFL score of 90 (Internet-based test) with scores for individual sections not lower than 22 on listening, 17 on writing, 21 on reading, and 21 on speaking; **OR** a minimum IELTS overall band score of 6.5, with no component below 6.0. These are irrespective of the admission requirements of the intended overseas universities. Test must be taken **on or after 19 February 2017**.

Application Procedures

1. Application form is obtainable from the website of the Office of Admissions and Financial Aid at <http://admission.cuhk.edu.hk/> (Financing Your Studies → Scholarships → Open for Applications).
2. Completed application form together with all requisite documents (please refer to the "Checklist of Supporting Documents" for details) should be submitted **IN PERSON** to the Scholarships and Financial Aid Section, Office of Admissions and Financial Aid, Room 1202, 12/F, Yasumoto International Academic Park during office hours (Monday – Friday 8:45 a.m. – 1:00 p.m. and 2:00 p.m. – 5:30 p.m. except Public Holidays) **on or before 27 December 2018**. **Late or incomplete applications will not be processed.**
3. Suitable candidates are required to attend a selection interview held in and by the University in late January 2019. Shortlisted candidates are then required to attend a HSBC panel interview in person in Hong Kong in March 2019. No phone interview/ interview by skype will be arranged. The cost of travel to the interviews will not be reimbursed to the candidates.
4. Though the academic results for Term 1 of 2018/19 is not available yet, interested students should still submit their scholarship applications if they would like to be considered. However, only applicants who have eventually attained a CGPA (up to first term of 2018/19) of 3.7 (top 3% of class/department, or equivalent) will be shortlisted for further selection.
5. Applicants are strongly advised to sit for the TOEFL or IELTS Test by the end of 2018 in order to fit in the application schedule of this Scholarship Scheme. Delayed provision of TOEFL or IELTS Test score transcript will result in partial submission of his/her application, and his/her application will therefore not be processed.

September 2018

HSBC Overseas Scholarship Programme 2019/20: LIST OF OVERSEAS UNIVERSITIES

IMPORTANT: HSBC does not have any arrangements with the below listed universities whereby HSBC Scholars will be guaranteed admission. **Students are advised to pay the closest attention to application procedures and timeline to secure acceptance independent of HSBC.**

Australia

Australian National University
Monash University
University of Adelaide
University of Melbourne
University of New South Wales
University of Queensland
University of Sydney

Canada

Dalhousie University
McGill University
McMaster University
Simon Fraser University
University of Alberta
University of British Columbia
University of Montreal
University of Toronto
University of Victoria

France

Ecole Normale Supérieure, Paris
Ecole Polytechnique
ENS de Lyon
Pierre and Marie Curie Université

New Zealand

University of Auckland

Germany

Bielefeld University
Eberhard Karls University, Tübingen
Humboldt University of Berlin
Johann Wolfgang Goethe University Frankfurt am Main
Karlsruhe Institute of Technology
Ruprecht Karl University of Heidelberg
RWTH Aachen of Munich
Technical University of Munich
University of Bonn
University of Freiburg
University of Göttingen
University of Konstanz
University of Munich
University of Würzburg

Netherlands

Delft University of Technology
Eindhoven University of Technology
Erasmus University Rotterdam
Leiden University
University of Amsterdam
University of Groningen
University of Twente
Utrecht University
VU University Amsterdam
Wageningen University and Research Center

USA

Arizona State University
Boston College
Boston University
Brown University
California Institute of Technology
Carnegie Mellon University
Case Western Reserve University
Columbia University
Cornell University
Dartmouth College
Drexel University
Duke University
Emory University
George Washington University
Georgetown University
Georgia Institute of Technology
Harvard University
Indiana University
Iowa State University
Johns Hopkins University
Kent State University
Massachusetts Institute of Technology
Medical College of Georgia
Michigan State University
New York University
Northwestern University
Ohio State University
Princeton University
Purdue University
Rensselaer Polytechnic Institute
Rice University
Stanford University
Stony Brook University
Tufts University
University of Arizona
University of California, Berkeley
University of California, Davis
University of California, Irvine
University of California, Los Angeles
University of California, Riverside
University of California, San Diego
University of California, Santa Barbara
University of California, Santa Cruz
University of Chicago
University of Cincinnati
University of Colorado
University of Delaware
University of Hawaii
University of Illinois – Chicago
University of Illinois – Urbana -Champaign
University of Iowa

UK/Ireland

Lancaster University
London School of Economics & Political Science
Newcastle University
University of Aberdeen
University of Birmingham
University of Bristol
University of Cambridge
University of Dundee
University of Durham
University of Edinburgh
University of Exeter
University of Glasgow
University of Leeds
University of Liverpool
University of London (Birkbeck , Imperial
College,
King's College, Queen Mary, University College,
Royal Holloway)
University of Manchester
University of Nottingham
University of Oxford
University of Sheffield
University of Southampton
University of St Andrews
University of Sussex
University of York

Sweden
Karolinska Institutet
Lund University
Royal Institute of Technology
Stockholm University
Swedish University of Agricultural Sciences
Uppsala University

University of Maryland College Park
University of Massachusetts
University of Michigan
University of Minnesota
University of North Carolina, Chapel Hill
University of Notre Dame
University of Pennsylvania
University of Pittsburgh
University of Southern California
University of Utah
University of Virginia
University of Washington
University of Wisconsin
Vanderbilt University
Wake Forest University
Washington University Saint Louis
William & Mary
Yale University
Yeshiva University

Switzerland

École Polytechnique Federale of Lausanne
Swiss Federal Institute of Technology Zurich
University of Basel
University of Geneva
University of Lausanne
University of Zurich

Rest of Europe

Aarhus University (Denmark)
Catholic University of Leuven (Belgium)
Ghent University (Belgium)
Bocconi University (Bologna, Italy)
Erasmus University (Netherlands)
Pompeu Fabra University (Spain)
Technical University of Denmark
University of Barcelona (Spain)
University of Bergen (Norway)
University of Copenhagen
University of Helsinki (Finland)
University of Innsbruck (Austria)
University of Vienna (Austria)

HSBC Overseas Scholarship Programme 2019/20



☆ The Scholarship

The scholarship supports **local non-final-year full-time undergraduate students** to study in an overseas university for **either one semester or one academic year** in the academic year 2019/20.

☆ Value of the Scholarship

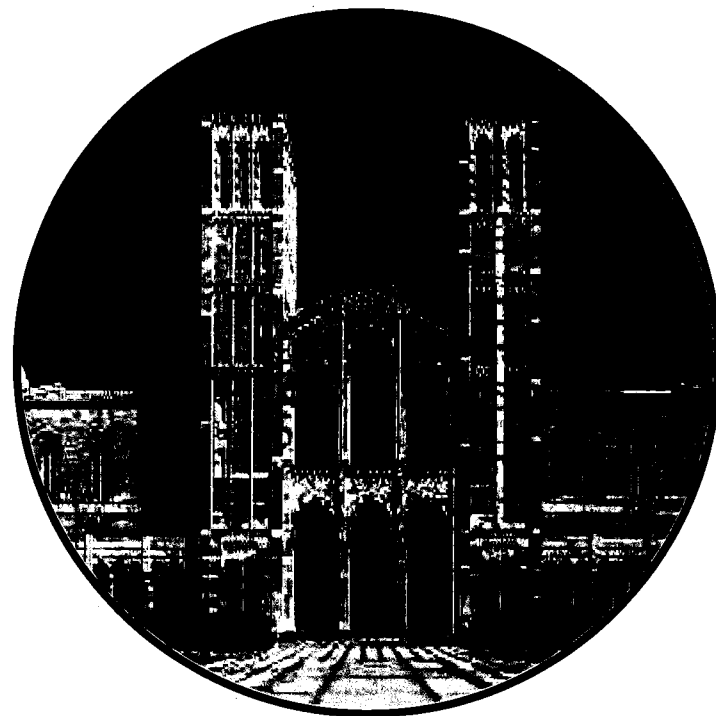
The maximum total value for each scholarship is HK\$300,000 covering tuition fees and mandatory college fees, a minimum economy return airfare, reasonable room and board costs, books, a small portion of living expenses and visa application fees.

☆ Eligibility

The applicants must be:

- Hong Kong permanent residents with the right of abode in Hong Kong;
- non-final-year full-time undergraduate students;
- with a minimum cumulative GPA score of 3.7 (top 3% of class, or equivalent); and
- with a minimum total TOEFL score of 90 (Internet-based test) **OR** a minimum IELTS overall band score of 6.5. Test must be taken **on or after 19 February 2017**.

For details of eligibility, please refer to the Information Sheet of this Scholarship which is available at <http://admission.cuhk.edu.hk/> (Financing Your Studies → Scholarships → Open for Applications).



☆ Application Procedures

Details of the Scholarship and its application form can be downloaded from our website at <http://admission.cuhk.edu.hk/> (Financing Your Studies → Scholarships → Open for Applications).

Completed application form together with supporting documents should be submitted **IN PERSON** to the Scholarships and Financial Aid Section, Office of Admissions and Financial Aid during office hours **on or before 27 December 2018**. **Late or incomplete applications will not be considered.**

☎ Enquiries

Please contact the Scholarships and Financial Aid Section, Office of Admissions and Financial Aid at sfas@cuhk.edu.hk or 3943 7204.

